

Description

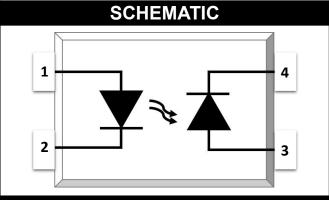
The TD618 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a photo diode in a plastic DIP4 package with different lead forming options. With the robust coplanar double mold structure, TD618 series provide the most stable isolation feature.

Features

- High isolation 5000 VRMS
- DC input with PD output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

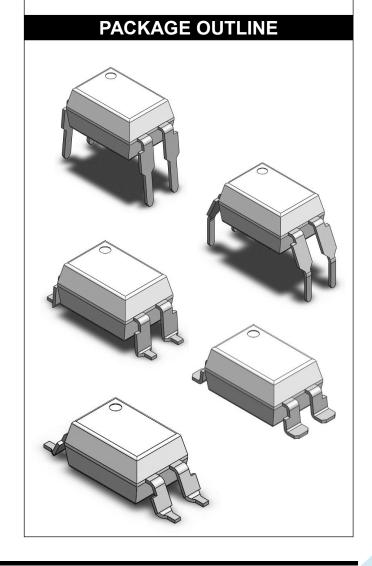
Applications

- Low cost analog isolation
- Monitor motor supply voltage
- Digital telephone isolation
- Transducer isolation



PIN DEFINITION

- 1. LED Anode
- 2. LED Cathode
 - 3. PD Anode
- 4. PD Cathode





ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	I _F	60	mA				
Peak Forward Current	I _{FP}	1	Α	1			
Reverse Voltage	V _R	6	V				
Input Power Dissipation	Pı	100	mW				
OUTPUT							
Output Photodiode Voltage	V_{PD}	80	V				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~150	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$



TD618 Series DIP4, DC Input, Linear Photo Coupler

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C								
PARAME	TER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT								
Forward V	oltage	V _F	-	1.24	1.4	V	IF=10mA	
Reverse C	Reverse Current		-	-	10	μA	VR=6V	
Input Capa	Input Capacitance		-	10	ı	pF	V=0, f=1kHz	
	OUTPUT							
Photo Di Leakage C		I _{LK}	-	0.5	25	nA	V _{KA} =15V, I _F =0mA	
Cathode-a		BV _{KAO}	30	-	-	V	I _{KA} =0.1mA,I _F =0mA	
Anode - ca		BV _{AKO}	0.5	-	-	V	I _{AK} =0.1mA,I _F =0mA	
TRANSFER CHARACTERISTICS								
Current Transfer Ratio	TD618	CTR	0.5	-	1	%	I _F =10mA, V _{KA} =5V	
Photo Diode Ca	apacitance	C _{PD}	-	22	-	pF	V=0, f=1kHz	
Isolation Resistance		R _{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C _{IO}	-	0.4	1	pF	V=0, f=1MHz	
Response Tir	- Time (Rise) tr - 1.3 10 μs VCC=3.3V, RD=510 Ω		VCC=3.3V, RD=510Ω	3				
Response Time (Fall)		tf	-	1.1	10	μs	RL=20kΩ, f=115200Hz	3

Note 3. Refer to Fig.7 & Fig.8

TA (°C)

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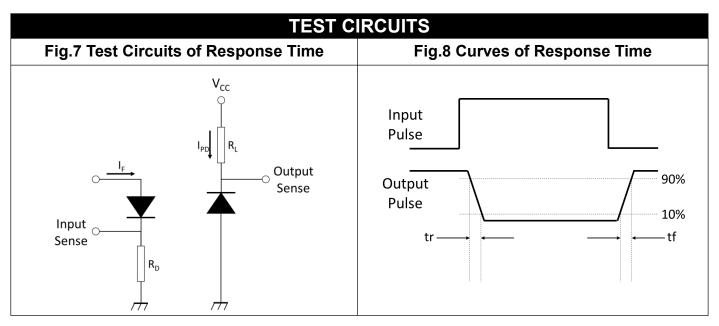
DIP4, DC Input, Linear Photo Coupler

CHARACTERISTIC CURVES Fig.2 Photo Diode Leakage Current Fig.1 Forward Current vs. Forward Voltage vs. Ambient Temperature 100 10000 1000 85°C I_F (mA) 25°C l_× (nA) -55°C 1.0 1.3 1.4 1.5 1.6 T_A (°C) $V_{F}(V)$ Fig.3 Normalized Current Transfer Ratio Fig.4 Normalized Current Transfer Ratio vs. Photo Diode Voltage vs. Forward Current 1.2 1.0 1.0 Normalized CTR Normalized CTR 0.6 0.6 Normalized to V_{PD}=5V 0.2 Normalized to I_z=10mA 0.2 $I_F = 10 \text{mA} \text{ } T_A = 25^{\circ}\text{C}$ V_{PD}=5V T_A=25°C 0.0 0.0 10 20 30 Fig.6 Normalized Current Transfer Ratio Fig.5 Normalized Current Transfer Ratio vs. Ambient Temperature vs. Ambient Temperature I_E=10mA √_{cc}=3.3∨ 1.2 2.5 T_=25°C 1.0 Response Time (µs) 20 Normalized CTR 0.8 0.6 0.5 Normalized to T_A=25°C 0.2 I_F=10mA V_{PD}=5V 0.0 0.0 20 40 80 5

Load Resistance ($k\Omega$)

Release Date: 2024/08/12



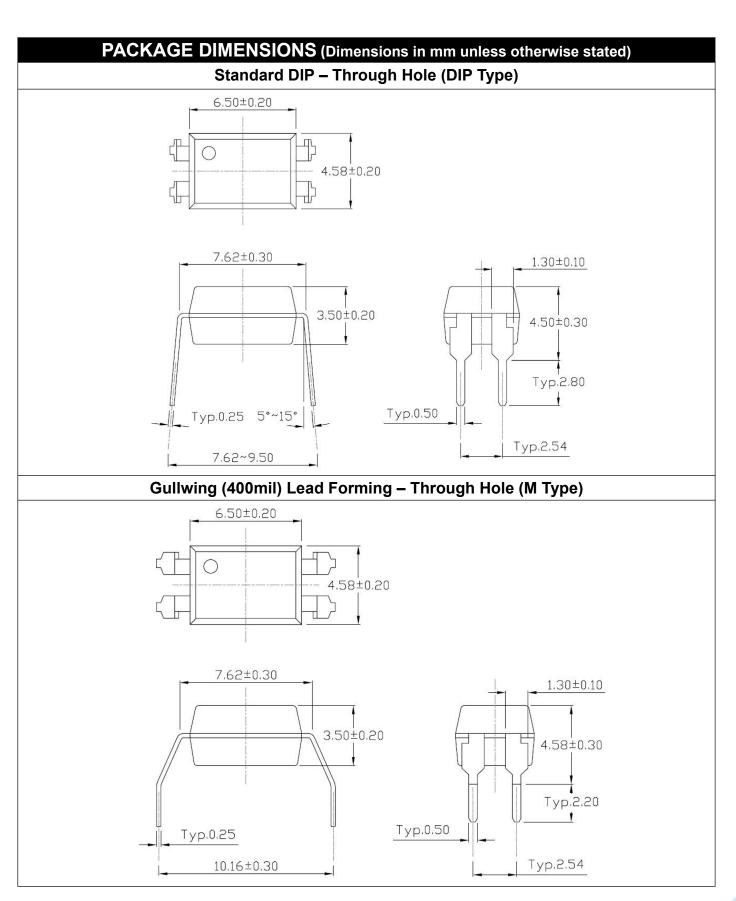




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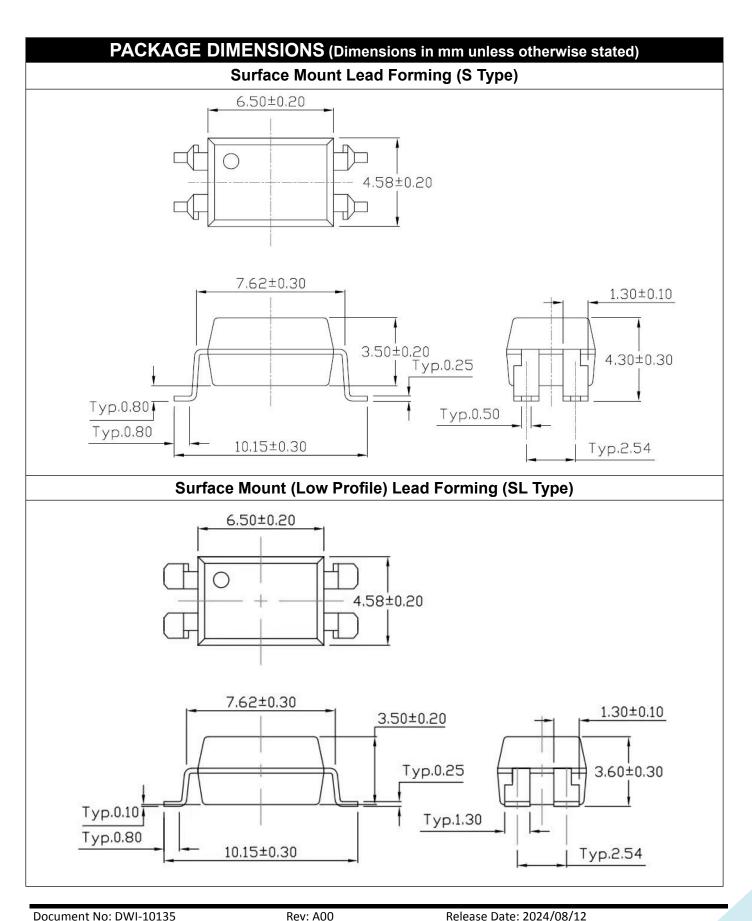
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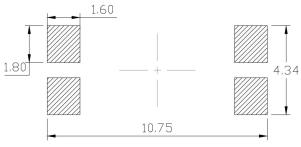
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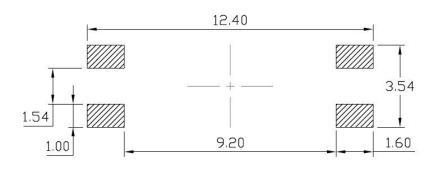




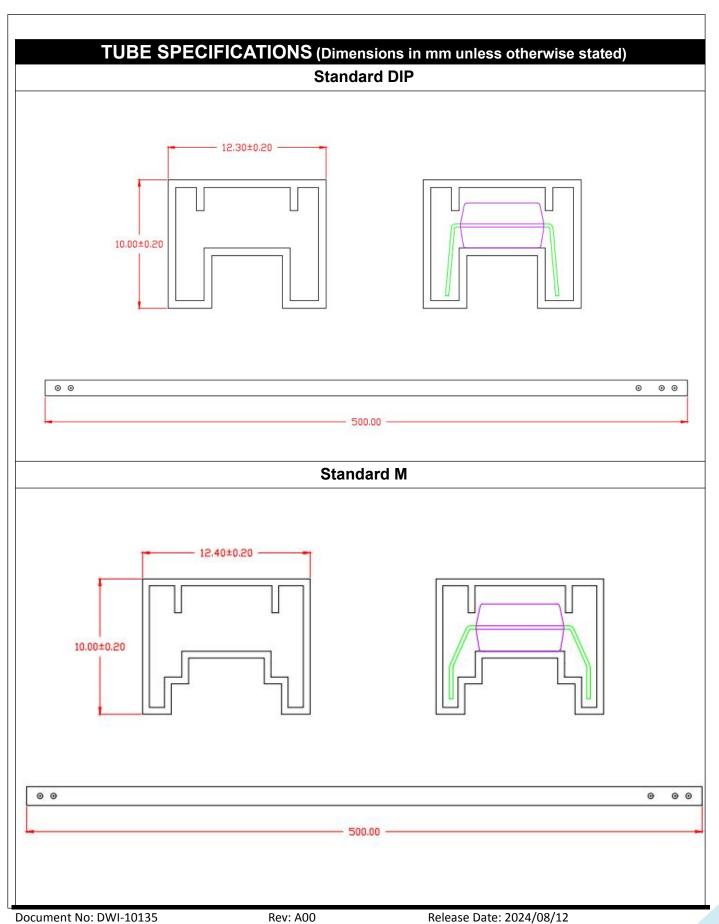
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) **Surface Mount (Gullwing) Lead Forming (SLM Type)** 6.50±0.20 4.58±0.20 0.40±0.10 7.62±0.30 1.30±0.10 3.50±0.20 3.75±0.30 Typ.0.25 0.25±0.20 Typ.0.50 0.60Min. 10.16±0.30 Typ.2.54 11,80±0,30 RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming 1.80 4.34



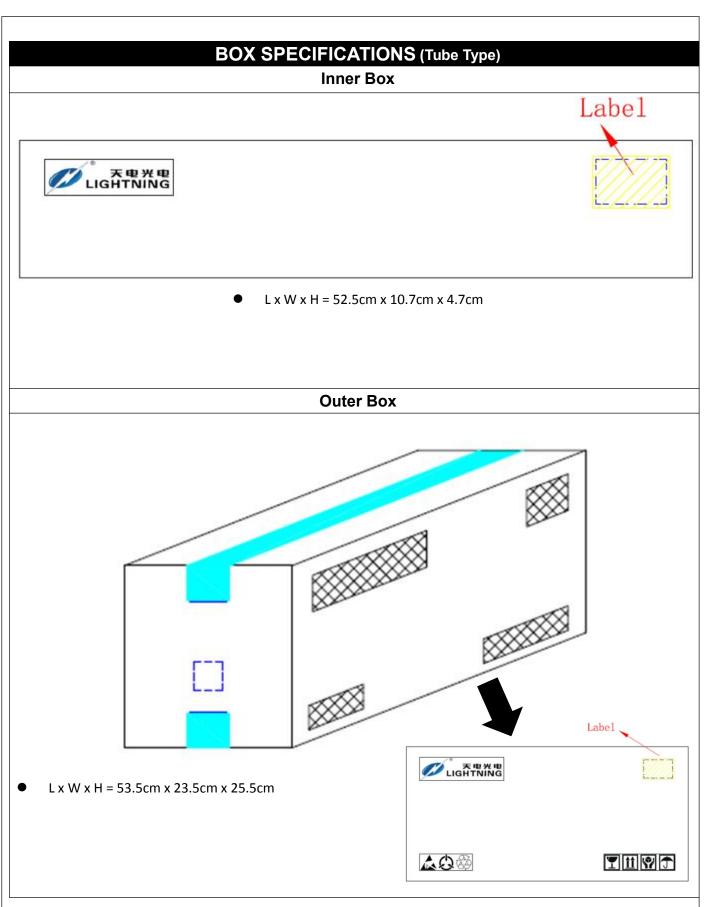
Surface Mount (Gullwing) Lead Forming



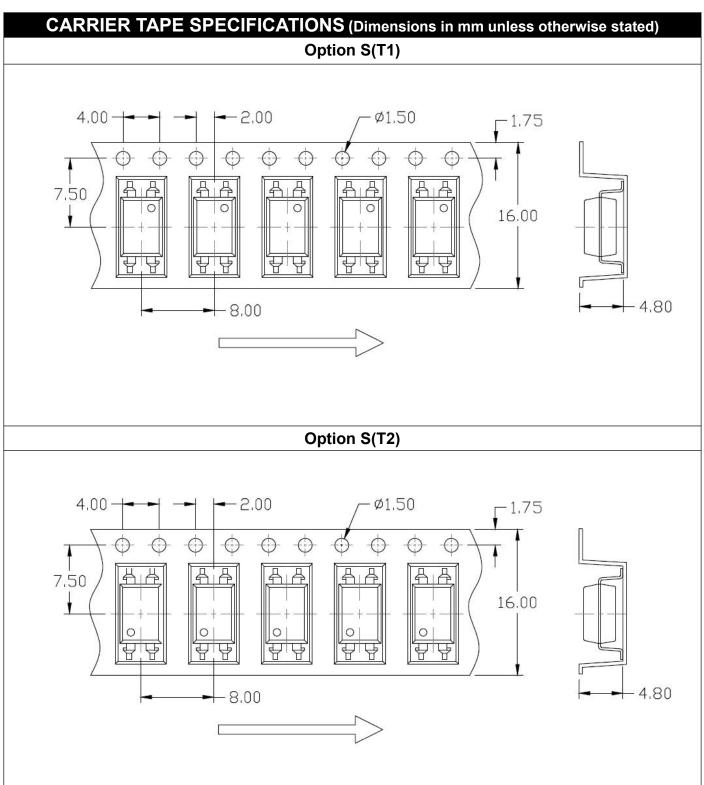




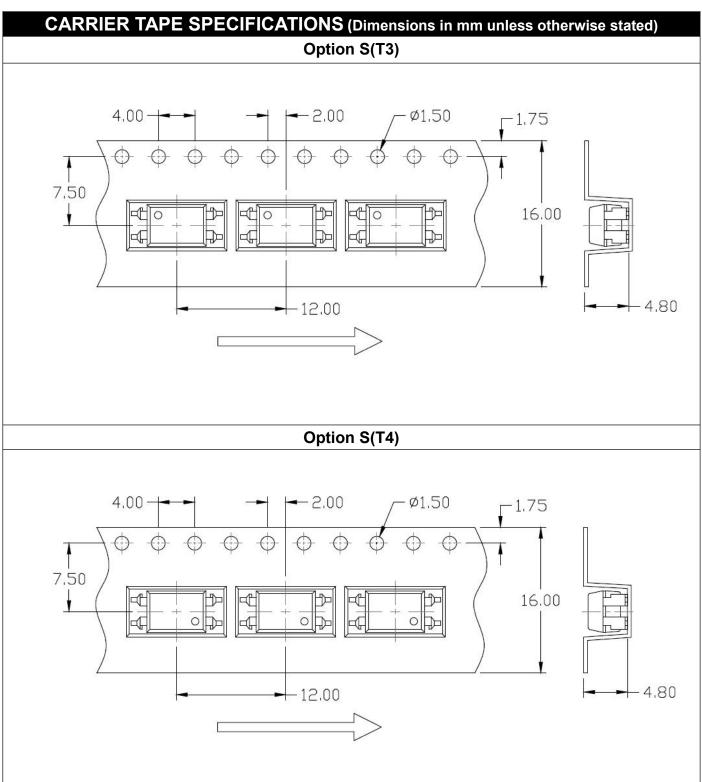




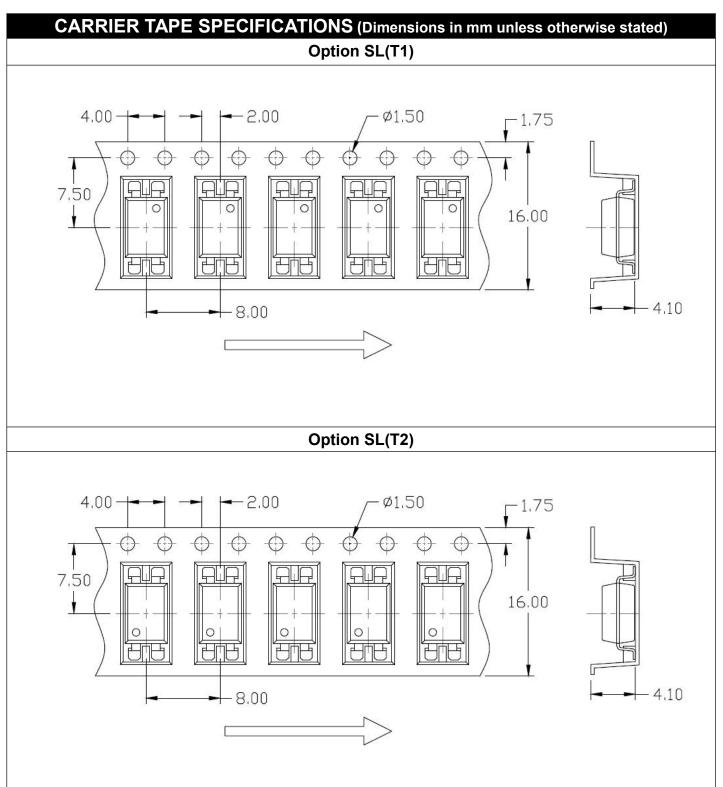




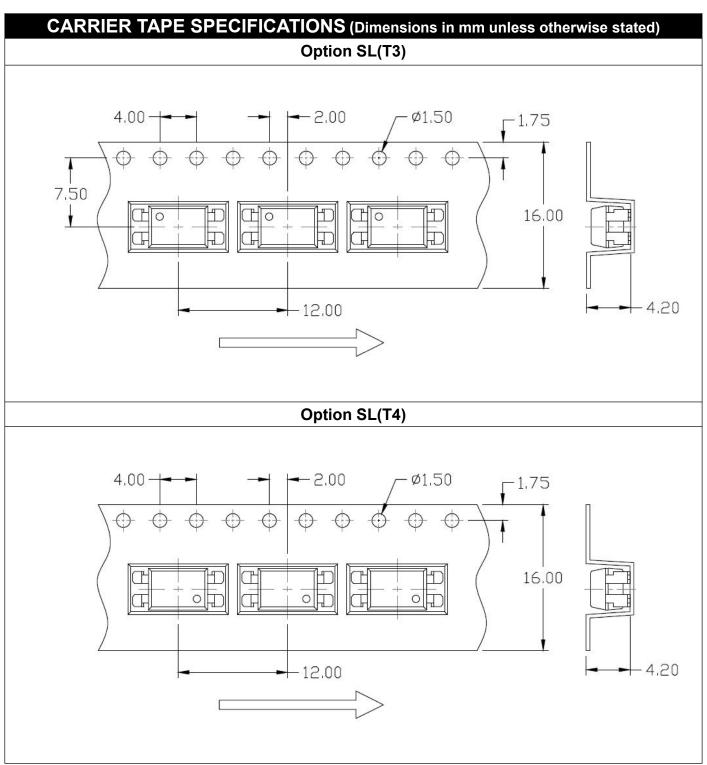




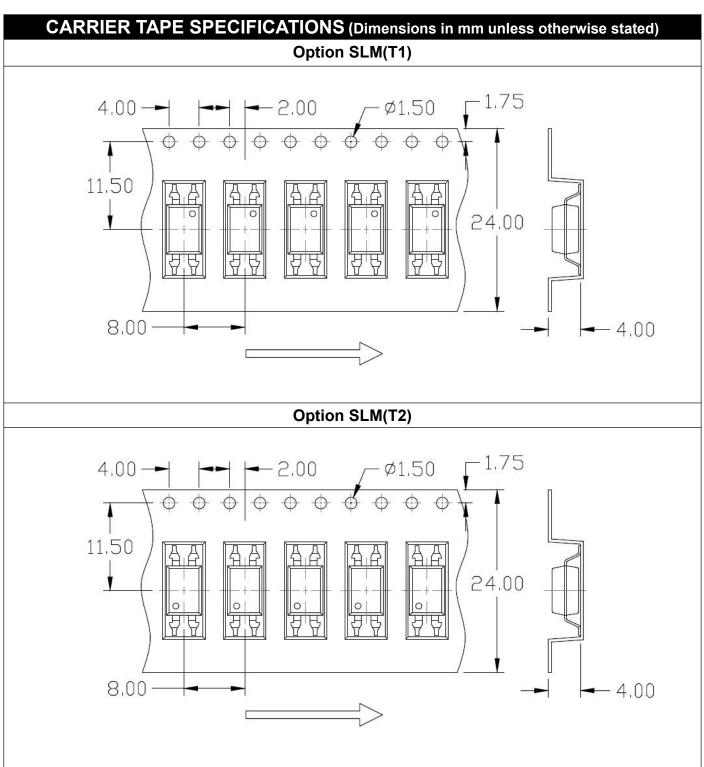




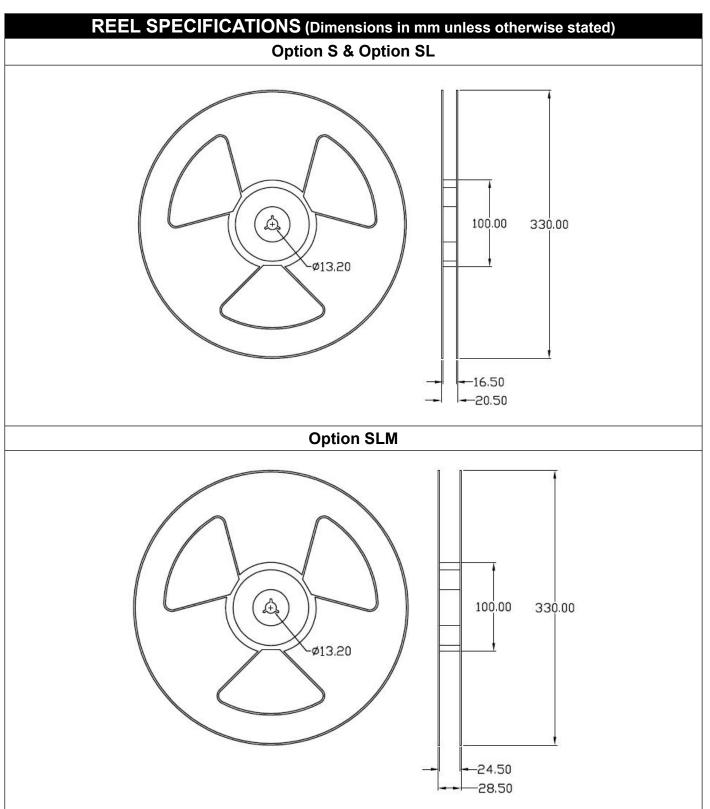








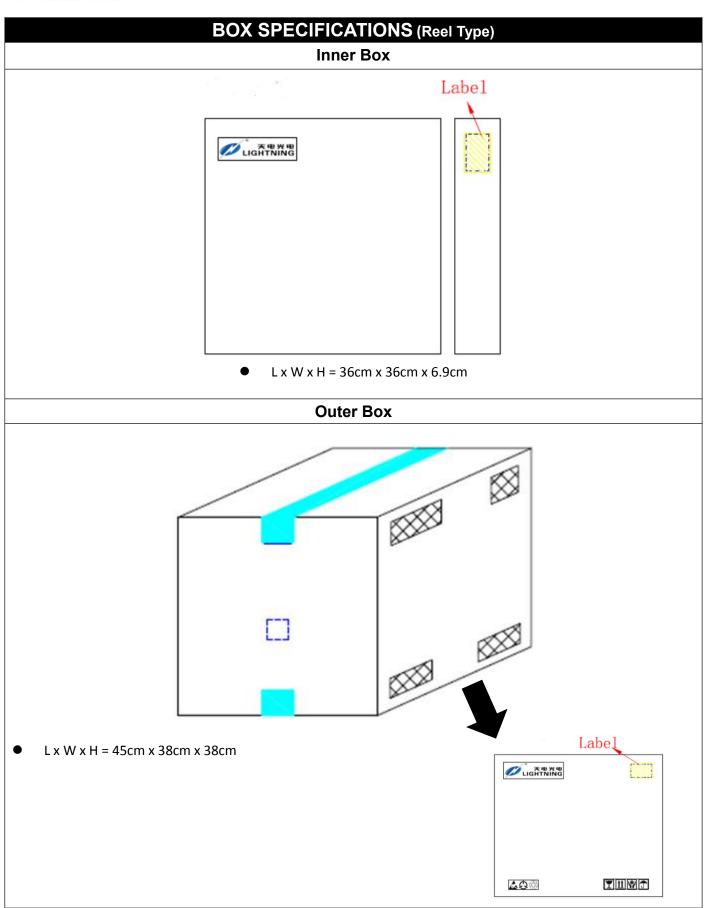






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DIP4, DC Input, Linear Photo Coupler



Rev: A00 Release Date: 2024/08/12



ORDERING AND MARKING INFORMATION

MARKING INFORMATION

TD 618 FVYAWW TD : Company Abbr.

618 : Part Number

F : Leadframe Option

V : VDE Option Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

ORDERING INFORMATION

TD618(Y)(Z)-FGV

TD - Company Abbr.

618 - Part Number

Y – Lead Form Option (M/S/SL/SLM/None)

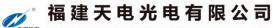
Z – Tape and Reel Option (T1/T2/T3/T4)

F – Leadframe Option (F:Iron, None:Copper)

G – Green

V – VDE Option (V or None)

LABEL INFORMATION



FUJIAN LIGHTNING OPTOELECTRONIC CO., LTD.

Part No : XXXXXXXXXXXXXX Bin Code : X



Lot No : XXXXXXXXXX Date Code : XXXX

Q'ty: XXXX pcs





Packing Quantity

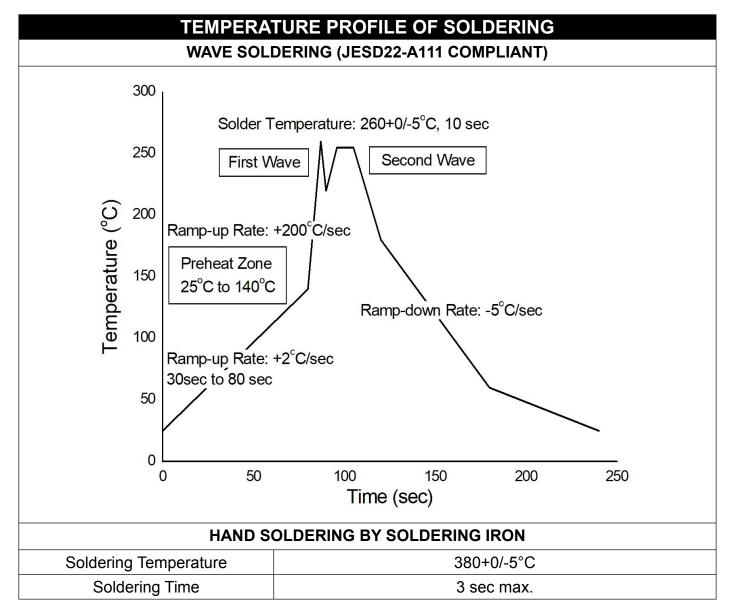
Packing Quantity				
Option	Quantity	Quantity - Inner box	Quantity – Outer box	
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
М	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units	
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units	
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T1)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	
SLM(T2)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units	



REFLOW INFORMATION REFLOW PROFILE Supplier T_p ≥ T_c User $T_p \le T_c$ T_C -5°C T_p T_c -5°C Temperature 📑 Max. Ramp Up Rate = 3°C/s Max. Ramp Down Rate = 6°C/s T_L T_{smax} Preheat Area T_{smin} 25 Time 25°C to Peak -IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- Immerge unit's body in solder paste is not recommended.
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 over time. All operating parameters, including typical parameters, must be validated in each
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